

(c) .678

(d) .476

1-d. Technology in which use of a layered silicon-insulator-silicon substrate in place of conventional silicon substrates in semiconductor manufacturing is referred as (CO4) 1

(a) SOI

(b) SOS

(c) IOI

(d) SiO

1-e.analog-to-digital converters (ADCs) use no clock signal, because there is no timing of sequencing require (CO5) 1

(a) Flash

(b) Actuator

(c) Bipolar

(d) Dual

2. Attempt all parts:-

2.a. What do you mean by Plasma Oxidation? (CO1) 2

2.b. What is the width of the depletion layer at the onset of inversion? (CO2) 2

2.c. Why nanowires are important in devices? (CO3) 2

2.d. Is FD-SOI compatible with cost-sensitive? (CO4) 2

2.e. What is Logic Gates? (CO5) 2

SECTION B

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3. Answer any five of the following:-

3-a. Explain the working principle of Quantum effects with suitable diagram (CO1) 4

3-b. How to overcome the noise problem in MOSFET Scaling? (CO1) 4

3-c. Write the boundary conditions for minimum gate insulator thickness in the DG MOS system (CO2) 4

3-d. Enlist the problem associated with Miller overlap capacitance (CO2) 4

3.e. Explain the band structure of graphene. (CO3) 4

3.f. How we calculate the performance of single gate SOI? (CO4) 4

3.g. What is op-amp and write its applications? (CO5) 4

SECTION C

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4. Answer any one of the following:-

4-a. Discuss the Narrow channel effect in detail and justify that due to this effect how threshold voltage is greater than normal channel devices? (CO1) 7

4-b. What do you mean by ITRS? How its report set a benchmark for the semiconductor industry? (CO1) 7

5. Answer any one of the following:-

5-a. Explain semiconductor thickness effect in detail. Also draw the graph between energy and semiconductor thickness (CO2) 7

5-b. Explain Two-dimensional confinement in MOS structure with suitable diagram (CO2) 7

6. Answer any one of the following:-

6-a. Explain Schottky barrier carbon nanotube FETs with suitable diagram (CO3) 7

6-b. Define I-V characteristics for carbon nanotube FETs. (CO3) 7

7. Answer any one of the following:-

7-a. Explain advanced multi-gate devices in detail. (CO4) 7

7-b. Explain the total ionizing dose effects on various gate devices. (CO4) 7

8. Answer any one of the following:-

8-a. Explain the impact of device performance on digital circuits. (CO5) 7

8-b. Write the short notes on - (CO5) 7

- i) Band gap voltage reference
- ii) Signal to Noise ratio and its practical significance
- iii) Flicker Noise calculation process